# LNJ8L4C38RA

## Hight Bright Surface Mounting Chip LED

### 3528 (PLCC4) Type

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P <sub>D</sub>	190	mW	
Forward current	I <sub>F</sub>	70	mA	
Pulse forward current *	I <sub>FP</sub>	100	mA	
Reverse voltage	V <sub>R</sub>	5	V	
Junction temperature	Tj	125	°C	
Thermal resistance	R <sub>th</sub>	130	°C/W	
Operating ambient temperature	T <sub>opr</sub>	-40 to +105	°C	
Storage temperature	T <sub>stg</sub>	-40 to +125	°C	

Lighting Color

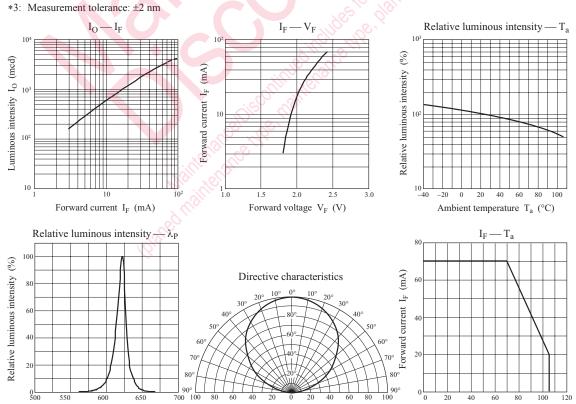
• Red

#### Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Storage temperature	T <sub>stg</sub>	-40 to $+125$	°C				
Note) *: The condition of I <sub>FP</sub> is duty 10%, Pulse	width 1 mse	c.					
Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$						S. N	30,23
Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity *1	Io	$I_F = 50 \text{ mA}$		2260	2800	4 500	mcd
Reverse current	I <sub>R</sub>	$V_R = 5 V$		ii,	, <u>, , , , , , , , , , , , , , , , , , </u>	10	μΑ
Forward voltage *2	V <sub>F</sub>	$I_F = 50 \text{ mA}$		2.05	2.30	2.50	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_F = 50 \text{ mA}$			623		nm
Dominant emission wavelength *3	$\lambda_d$	$I_F = 50 \text{ mA}$		612	614	624	nm
Spectral half band width	Δλ	$I_F = 50 \text{ mA}$		SO.	20		nm

#### Note) \*1: Measurement tolerance: $\pm 11\%$

\*2: Measurement tolerance: ±0.15 V



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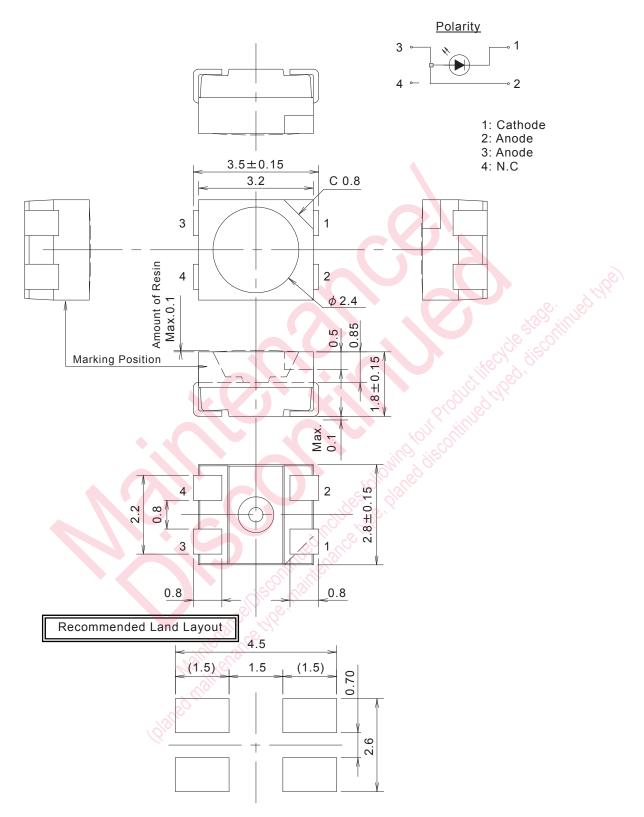
Peak emission wavelength  $\lambda_P$  (nm)

Ver. BEK

Relative luminous intensity (%)

Ambient temperature T<sub>a</sub> (°C)

Package (Unit: mm)



(Note1) Tolerance unless specified: ±0.1 mm.

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